

#### STE140NF20D

# N-channel 200 V, 10 mΩ typ., 140 A STripFET™ II Power MOSFET (with fast diode) in an ISOTOP package

Datasheet - production data

#### **Features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STE140NF20D	200 V	< 0.012 Ω	140 A

- Exceptional dv/dt capability
- Low gate charge
- 100% avalanche tested

#### **Applications**

Switching applications

#### **Description**

This Power MOSFET is produced using STMicroelectronics' unique STripFET<sup>TM</sup> process, which is specifically designed to minimize input capacitance and gate charge. The device offers extremely fast switching performance thanks to the intrinsic fast body diode, making the device ideal for hard switching topologies.

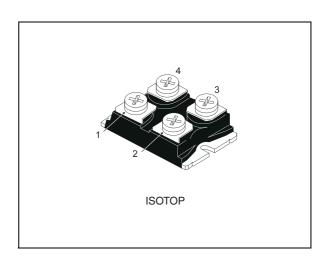


Figure 1. Internal schematic diagram

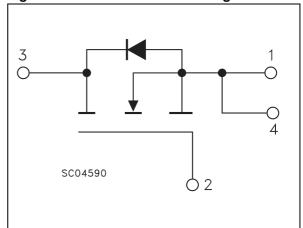


Table 1. Device summary

Order code	Marking	Package	Packaging
STE140NF20D	140NF20D	ISOTOP	Tube

Contents STE140NF20D

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STE140NF20D Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	200	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	140	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> =100 °C 88		Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	560	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	500	W
I <sub>AR</sub> <sup>(2)</sup>	Avalanche current, repetitive or not repetitive	140	Α
E <sub>AS</sub> <sup>(3)</sup>	Single pulse avalanche energy	800	mJ
dv/dt <sup>(4)</sup>	Peak diode recovery voltage slope	25	V/ns
V <sub>ISO</sub>	Insulation winthstand voltage (AC-RMS)	2500	V
T <sub>J</sub> T <sub>stg</sub>	Operating junction temperature Storage temperature	- 55 to 150	°C

<sup>1.</sup> Pulse width limited by safe operating area

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	0.25	°C/W
R <sub>thj-amb</sub> Thermal resistance junction-ambient		40	°C/W

<sup>2.</sup> Pulse width limited by Tjmax

<sup>3.</sup> Strating Tj = 25 °C,  $I_D = I_{AR}$ ,  $V_{DD} = 50 \text{ V}$ 

<sup>4.</sup>  $I_{SD} \leq$  140 A, di/dt  $\leq$  1000 A/ $\mu$ s,  $V_{DD} \leq$  80%  $V_{(BR)DSS}$ 

Electrical characteristics STE140NF20D

#### 2 Electrical characteristics

(T<sub>CASE</sub> = 25 °C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0	200			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 200 V, V <sub>DS</sub> = 200 V, T <sub>C</sub> = 125 °C			10 100	μA μA
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ±20 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R <sub>DS(on)</sub>	Static drain-source on resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 70 A		10	12	mΩ

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>DS</sub> = 25 V, f=1 MHz, V <sub>GS</sub> =0	-	11100 2190 334	-	pF pF pF
C <sub>o(tr)</sub> (1)	Equivalent capacitance time related	$V_{DS} = 0$ to 160 V, $V_{GS} = 0$ ,	-	1525	-	pF
C <sub>o(er)</sub> (2)	Equivalent capacitance energy related	V <sub>DS</sub> = 0 to 100 v, v <sub>GS</sub> = 0,	-	1139	-	pF
R <sub>g</sub>	Intrinsic gate resistance	f = 1 MHz open drain	-	1.4	-	Ω
$egin{array}{c} Q_{ m g} \ Q_{ m gd} \end{array}$	Total gate charge $V_{DD} = 160 \text{ V}, I_{D} = 140 \text{ A},$ Gate-source charge $V_{GS} = 10 \text{ V}$ (see Figure 16)		-	338 47 183	•	nC nC nC

<sup>1.</sup> Time related is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 

<sup>2.</sup> Energy related is defined as a constant equivalent capacitance giving the same stored energy as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ 

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$\begin{array}{c} t_{\text{d(on)}} \\ t_{\text{r}} \\ t_{\text{d(off)}} \\ t_{\text{f}} \end{array}$	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD}$ = 100 V, $I_{D}$ = 70 A, $R_{G}$ =4.7 $\Omega$ , $V_{GS}$ =10 V (see Figure 15)	-	232 218 283 250	-	ns ns ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		140	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		560	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 140 A, V <sub>GS</sub> =0	-		1.5	V
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 140 A,		190		ns
$Q_{rr}$	Reverse recovery charge	di/dt = 100 A/μs,	-	1.4		nC
I <sub>RRM</sub>	Reverse recovery current	V <sub>DD</sub> = 60 V		14		Α
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 140 A,		257		ns
$Q_{rr}$	Reverse recovery charge	di/dt = 100 A/μs,	-	2.4		μC
I <sub>RRM</sub>	Reverse recovery current	V <sub>DD</sub> = 60 V, Tj=150 °C		18		Α

<sup>1.</sup> Pulse width limited by safe operating area

<sup>2.</sup> Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

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#### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

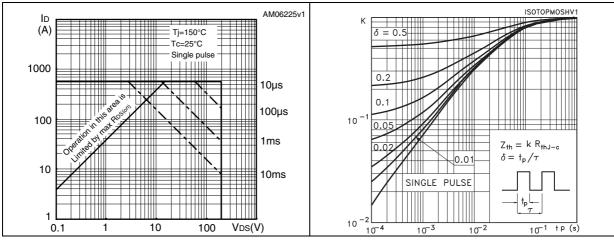


Figure 4. Output characteristics

Figure 5. Transfer characteristics

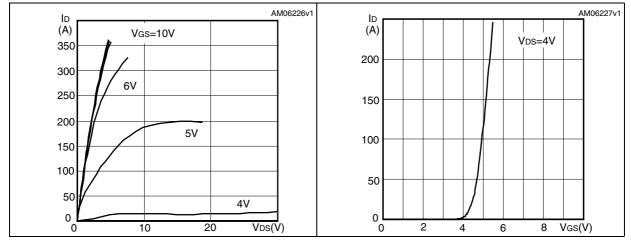


Figure 6. Gate charge vs gate-source voltage Figure 7. Static drain-source on-resistance

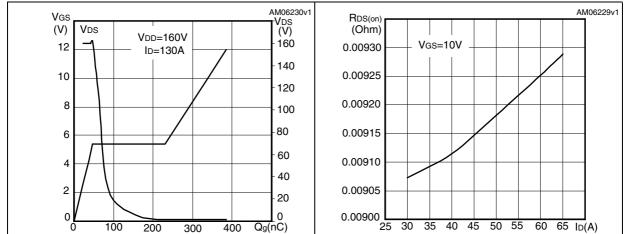
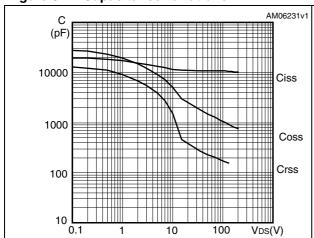


Figure 8. **Capacitance variations** 

Figure 9. Output capacitance stored energy



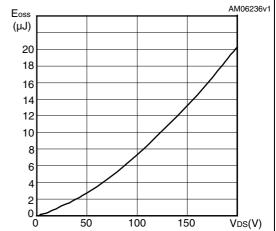
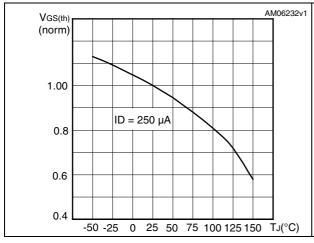
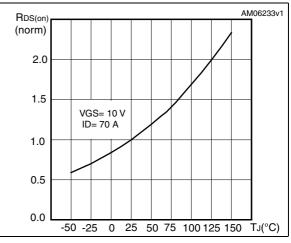


Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature

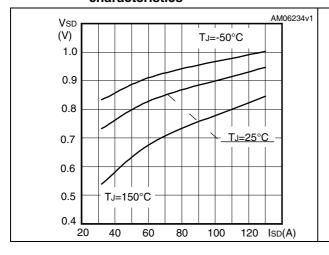
temperature

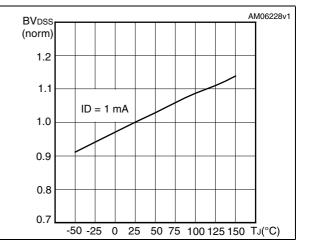




Source-drain diode forward Figure 12. characteristics

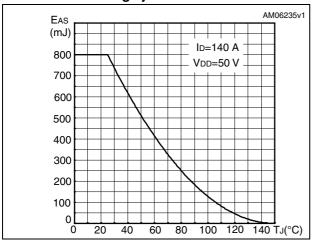
Normalized  $B_{VDSS}$  vs temperature Figure 13.





Electrical characteristics STE140NF20D

Figure 14. Maximum avalanche energy vs starting Tj



STE140NF20D Test circuits

## 3 Test circuits

Figure 15. Switching times test circuit for resistive load

Figure 16. Gate charge test circuit

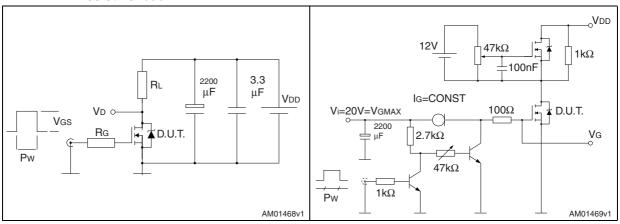


Figure 17. Test circuit for inductive load switching and diode recovery times

Figure 18. Unclamped inductive load test circuit

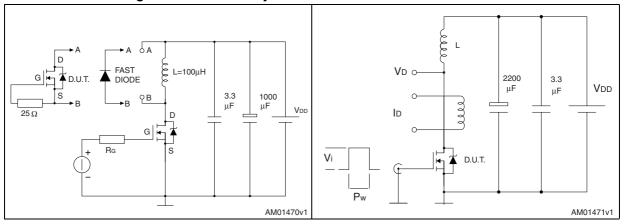
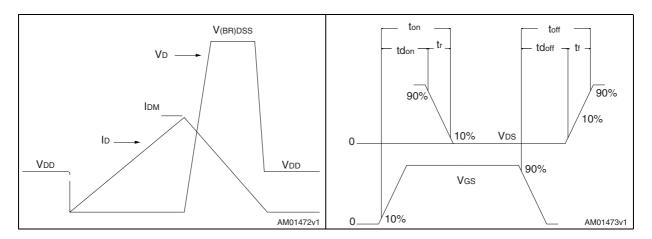


Figure 19. Unclamped inductive waveform

Figure 20. Switching time waveform



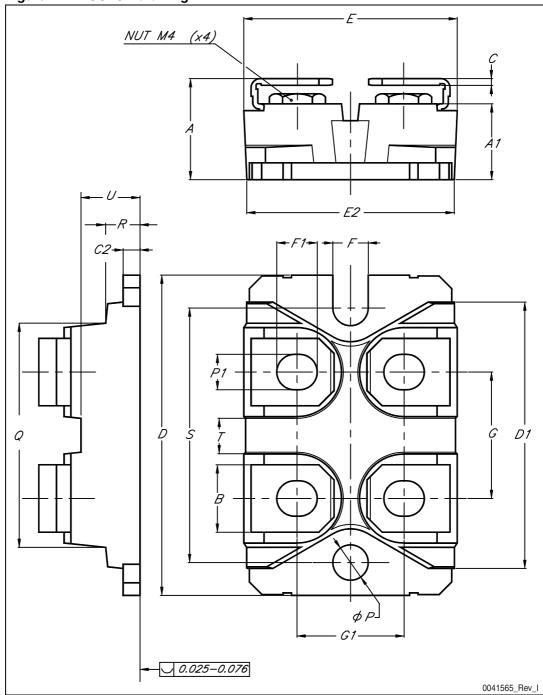
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 8. ISOTOP mechanical data

Dim.		mm	
Diiii.	Min.	Тур.	Max.
Α	11.76		12.19
A1	8.92		9.58
В	7.80		8.18
С	0.76		0.84
C2	1.98		2.13
D	38		38.20
D1	31.50		31.70
E	25.20		25.45
E2	24.59		25.07
G	14.91		15.09
G1	12.57		12.83
F	4.09		4.19
F1	4.67		4.93
фР	4.09		4.27
P1	4.06		4.32
Q	26.54		26.90
R	3.94		4.42
S	30.12		30.30
Т	3.30		3.61
U	6.88		7.09

Figure 21. ISOTOP drawing



Revision history STE140NF20D

# 5 Revision history

Table 9. Document revision history

Date	Revision	Changes
27-Jan-2009	1	First release
18-Jan-2010	2	Document status promoted from preliminary data to datasheet.
01-Jul-2010	3	Inserted V <sub>ISO</sub> parameter in <i>Table 2: Absolute maximum ratings</i>
17-Oct-2012	4	Updated: Figure 1, 5, 6, 10, 11, 13.  Updated: I <sub>SD</sub> value in note 4 (below Table 2: Absolute maximum ratings).  Updated: I <sub>DSS</sub> and I <sub>GSS</sub> values (test conditions) in Table 4: On/off states.  Updated: Section 4: Package mechanical data.  Minor text changes.

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